General Purpose ABS, POLYLAC® PA-717C

Processing Conditions

A. Pre-drying 80 ~ 85 °C x 2 ~ 4 hrs

depending on
a) Humidity
b) Ratio of reground resin
c) Storage conditions

B. Barrel Setting Profile

MAX(°C) 230 230 220
MIN(°C) 190 190 180

C. Mold Temperature 30~70 °C

depending on
a) Thickness
b) Dimension
c) Gate and runner system

NOTE:
1. Keep the resin from dust and contamination during handling and production.
2. Do not retain the hot melt at the barrel for a long time between injection cycles.
3. Temperature setting of manifold system should not exceed 240 °C to avoid melt from degraded.

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